

D4F60**General Rectifying Diodes****600V, 4.0A****Feature**

- Small SMD
- High $I_{F(\text{AV})}$
- Available for automotive use
- Pb free terminal
- RoHS:Yes

OUTLINE**Package (House Name): 2F****Equivalent circuit****Absolute Maximum Ratings** (unless otherwise specified : $T_{\text{I}}=25^{\circ}\text{C}$)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	T_{stg}		-55 to 150	$^{\circ}\text{C}$
Junction temperature	T_j		-55 to 150	$^{\circ}\text{C}$
Repetitive peak reverse voltage	V_{RRM}		600	V
Average forward current	$I_{F(\text{AV})}$	50Hz sine wave, Resistance load, $T_{\text{I}}=68^{\circ}\text{C}$	4	A
Average forward current	$I_{F(\text{AV})}$	50Hz sine wave, Resistance load, On alumina substrate, $T_{\text{a}}=25^{\circ}\text{C}$ ※	1.85	A
Average forward current	$I_{F(\text{AV})}$	50Hz sine wave, Resistance load, On glass-epoxy substrate, $T_{\text{a}}=25^{\circ}\text{C}$ ※	1.3	A
Surge forward current	I_{FSM}	50Hz sine wave, Non-repetitive 1 cycle peak value, $T_j=25^{\circ}\text{C}$	200	A
Current squared time	I^2t	$1\text{ms} \leq t_p < 10\text{ms}$, $T_j=25^{\circ}\text{C}$	150	A^2s

※ : See the original Specifications

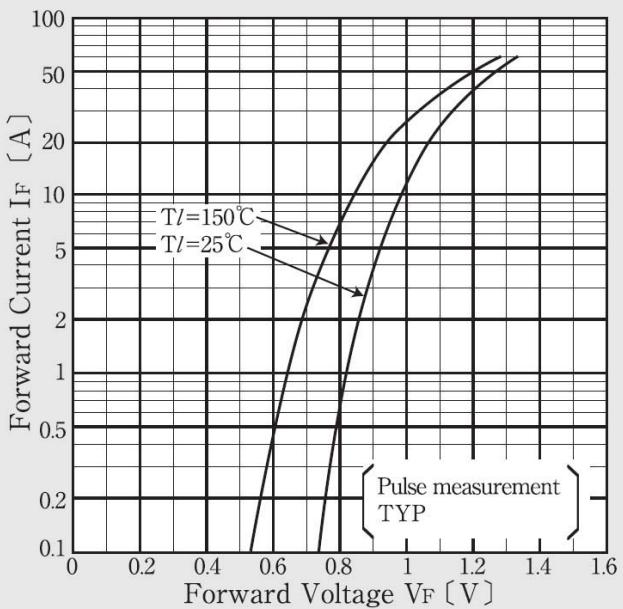
Electrical Characteristics (unless otherwise specified : Tl=25°C)

Item	Symbol	Conditions	Ratings			Unit
			MIN	TYP	MAX	
Forward voltage	V_F	IF=4A, Pulse measurement			0.95	V
Reverse current	I_R	VR=600V, Pulse measurement			10	μA
Thermal resistance	$R_{th(j-l)}$	Junction to lead			23	$^{\circ}C/W$
Thermal resistance	$R_{th(j-a)}$	Junction to ambient, On alumina substrate	※		80	$^{\circ}C/W$
Thermal resistance	$R_{th(j-a)}$	Junction to ambient, On glass-epoxy substrate	※		115	$^{\circ}C/W$

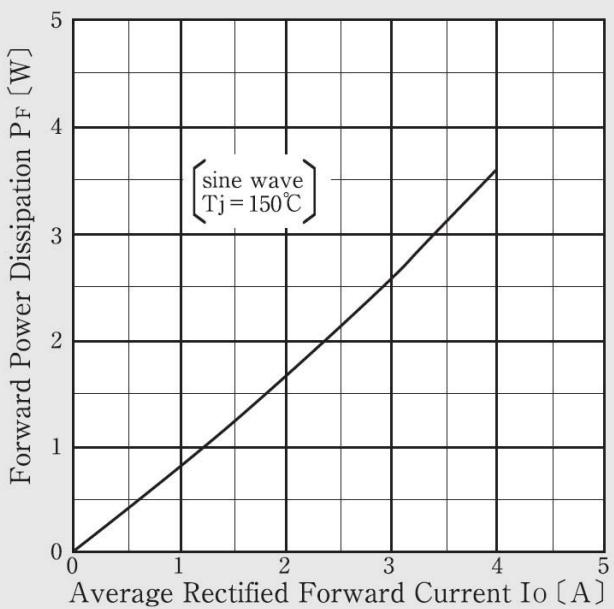
※ :See the original Specifications

CHARACTERISTIC DIAGRAMS

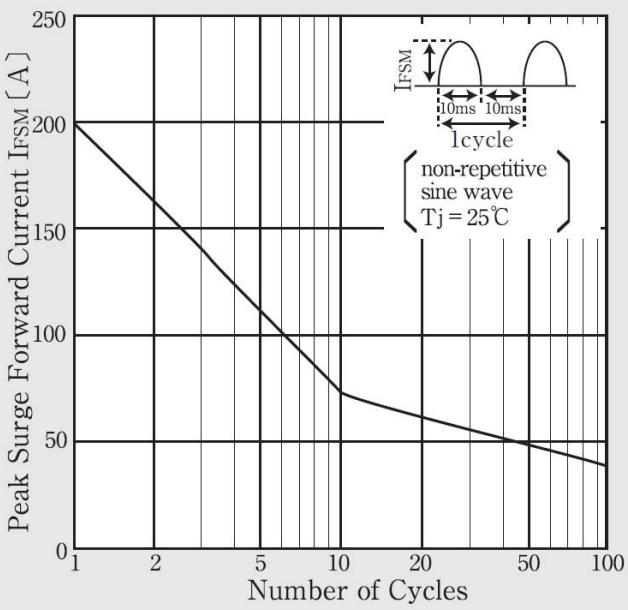
Forward Voltage



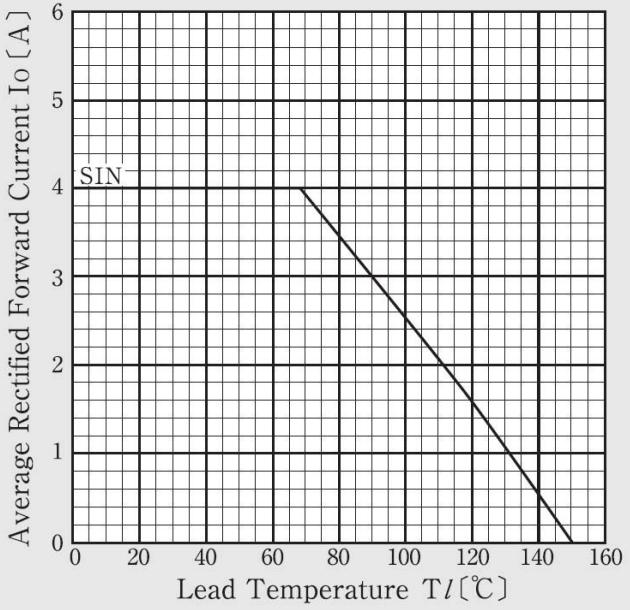
Forward Power Dissipation



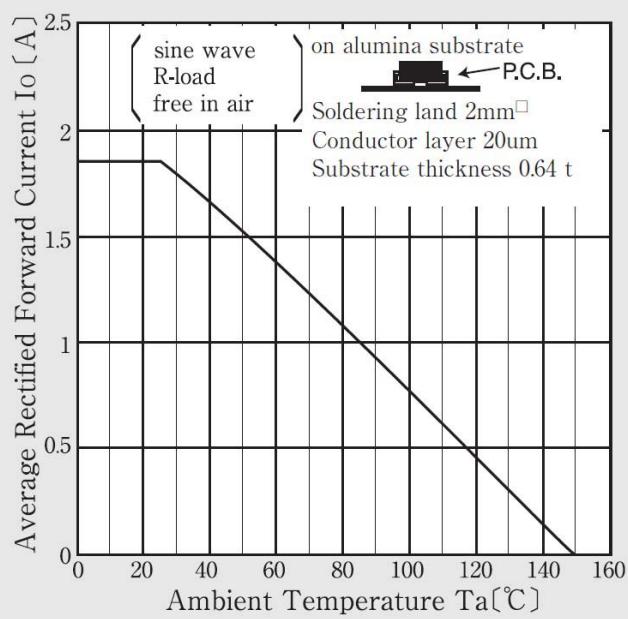
Peak Surge Forward Current Capability



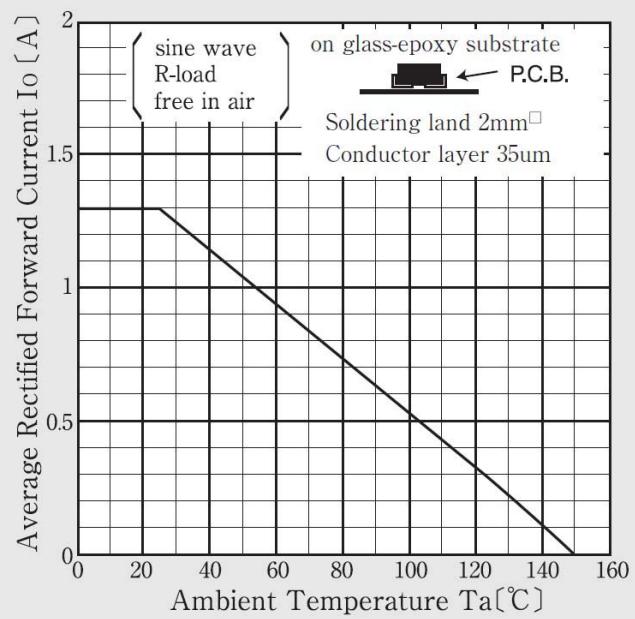
Derating Curve



Derating Curve



Derating Curve



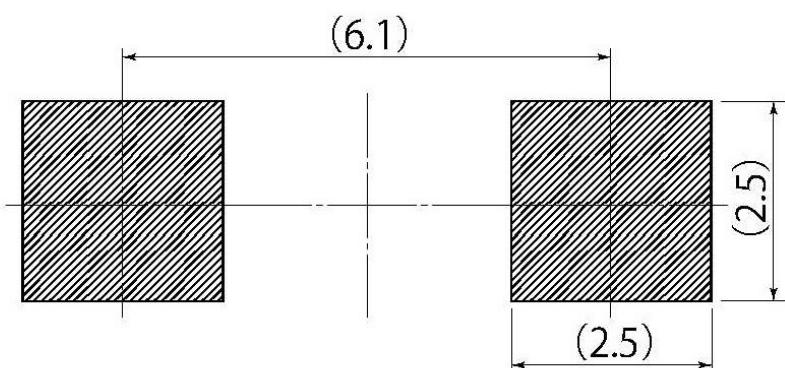
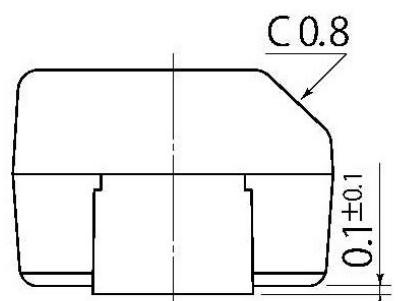
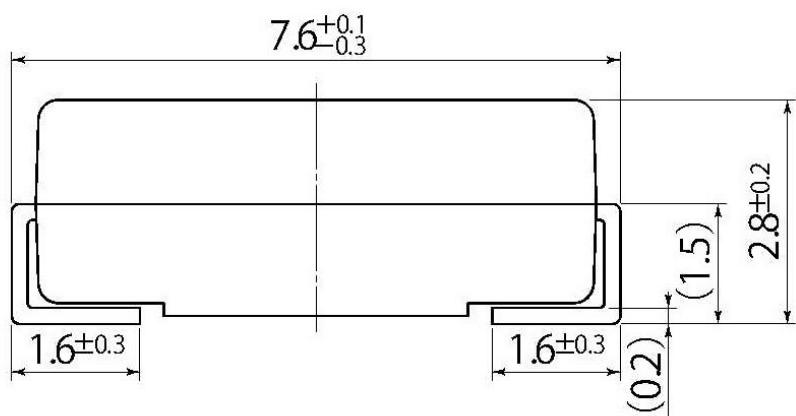
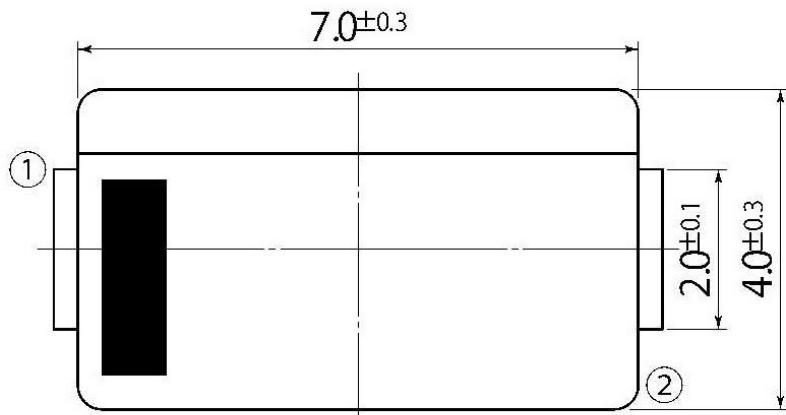
Outline Dimensions

unit:mm

scale: 10/1

B9

JEDEC Code	—
JEITA Code	—
House Name	2F



Referential Soldering Pad

- Optimize soldering pad to the board design and soldering condition.

Notes

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【Specific applications】

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